



**THE DATASHEET OF  
74LVC2G32DC,125**





# 74LVC2G32

Dual 2-input OR gate

Rev. 17 — 12 August 2024

Product data sheet

## 1. General description

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The 74LVC2G32 is a dual 2-input OR gate. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

## 2. Features and benefits

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- Wide supply voltage range from 1.65 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- 5 V tolerant outputs in the Power-down mode
- ±24 mA output drive (V<sub>CC</sub> = 3.0 V)
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
  - JESD36 (4.5 V to 5.5 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

### 3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
<a href="#">74LVC2G32DP</a>	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	<a href="#">SOT505-2</a>
<a href="#">74LVC2G32DC</a>	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	<a href="#">SOT765-1</a>
<a href="#">74LVC2G32GT</a>	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	<a href="#">SOT833-1</a>
<a href="#">74LVC2G32GN</a>	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	<a href="#">SOT1116</a>
<a href="#">74LVC2G32GS</a>	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	<a href="#">SOT1203</a>
<a href="#">74LVC2G32GX</a>	-40 °C to +125 °C	X2SON8	plastic thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.35 × 0.8 × 0.32 mm	<a href="#">SOT1233-2</a>

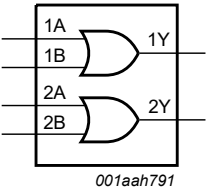
### 4. Marking

Table 2. Marking codes

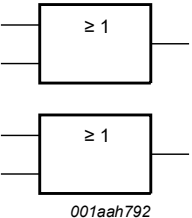
Type number	Marking code <sup>[1]</sup>
74LVC2G32DP	V32
74LVC2G32DC	V32
74LVC2G32GT	V32
74LVC2G32GN	VG
74LVC2G32GS	VG
74LVC2G32GX	VG

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

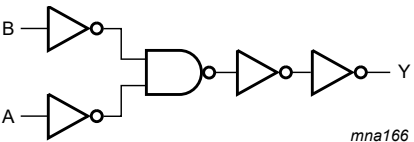
### 5. Functional diagram



**Fig. 1. Logic symbol**



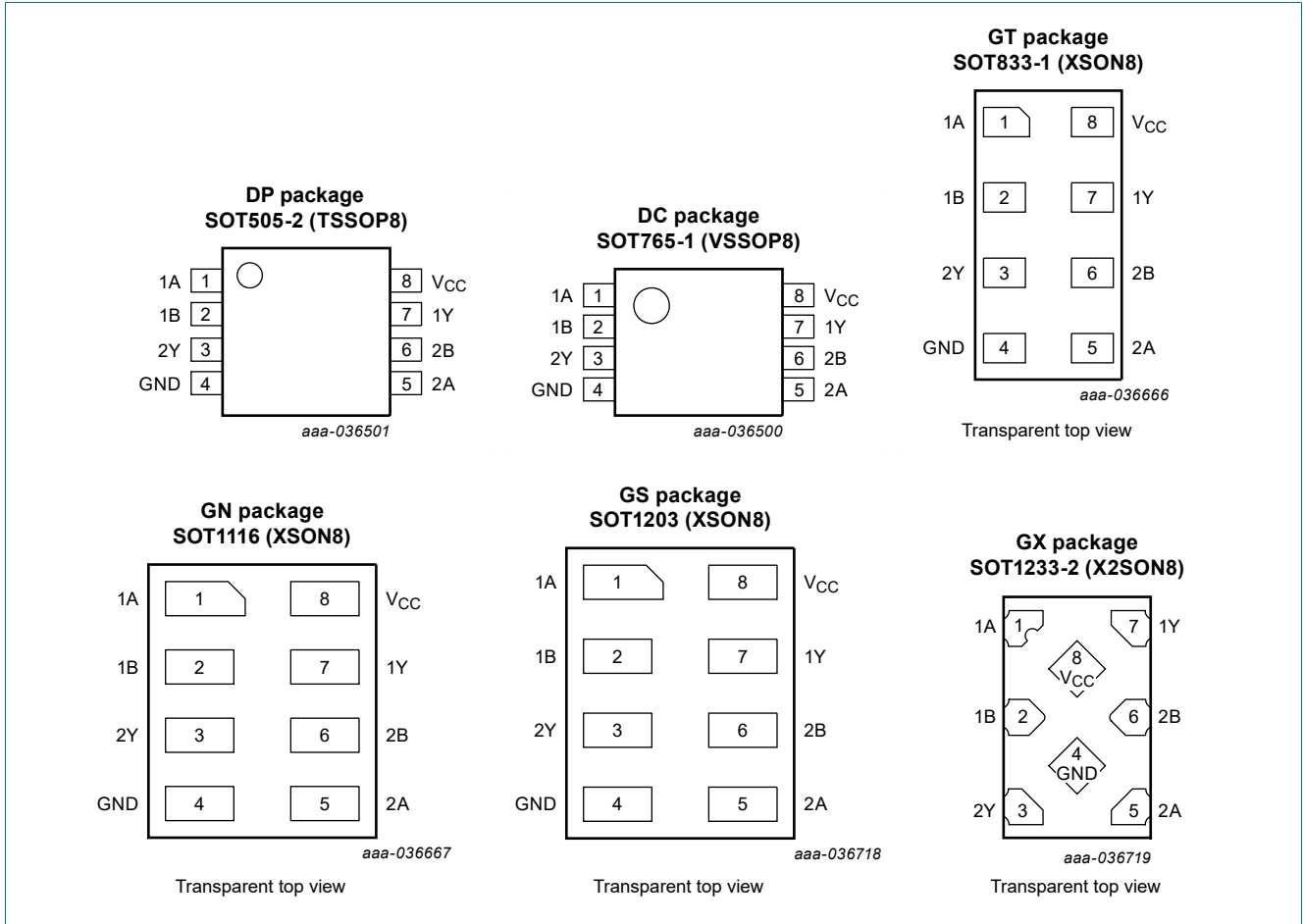
**Fig. 2. IEC logic symbol**



**Fig. 3. Logic diagram (one gate)**

## 6. Pinning information

### 6.1. Pinning



### 6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
1A, 2A	1, 5	data input
1B, 2B	2, 6	data input
GND	4	ground (0 V)
1Y, 2Y	7, 3	data output
V <sub>CC</sub>	8	supply voltage

## 7. Functional description

**Table 4. Function table**

*H = HIGH voltage level; L = LOW voltage level.*

Input		Output
nA	nB	nY
L	L	L
L	H	H
H	L	H
H	H	H

## 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
$V_I$	input voltage		[1] -0.5	+6.5	V
$V_O$	output voltage	Active mode	[1] -0.5	$V_{CC} + 0.5$	V
		Power-down mode; $V_{CC} = 0$ V	[1] -0.5	+6.5	V
$I_{IK}$	input clamping current	$V_I < 0$ V	-50	-	mA
$I_{OK}$	output clamping current	$V_O < 0$ V or $V_O > V_{CC}$	-	$\pm 50$	mA
$I_O$	output current	$V_O = 0$ V to $V_{CC}$	-	$\pm 50$	mA
$I_{CC}$	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C			
		SOT505-2 (TSSOP8) SOT765-1 (VSSOP8) SOT833-1 (XSON8) SOT1116 (XSON8) SOT1203 (XSON8)	[2] -	250	mW
		SOT1233-2 (X2SON8)	[3] -	300	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT505-2 (TSSOP8) package:  $P_{tot}$  derates linearly with 4.6 mW/K above 96 °C.

For SOT765-1 (VSSOP8) package:  $P_{tot}$  derates linearly with 4.9 mW/K above 99 °C.

For SOT833-1 (XSON8) package:  $P_{tot}$  derates linearly with 3.1 mW/K above 68 °C.

For SOT1116 (XSON8) package:  $P_{tot}$  derates linearly with 4.2 mW/K above 90 °C.

For SOT1203 (XSON8) package:  $P_{tot}$  derates linearly with 3.6 mW/K above 81 °C.

[3] For SOT1233-2 (X2SON8) package:  $P_{tot}$  derates linearly with 7.7 mW/K above 118 °C.

## 9. Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		1.65	5.5	V
$V_I$	input voltage		0	5.5	V
$V_O$	output voltage	Active mode	0	$V_{CC}$	V
		Power-down mode; $V_{CC} = 0$ V	0	5.5	V
$T_{amb}$	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65$ V to 2.7 V	-	20	ns/V
		$V_{CC} = 2.7$ V to 5.5 V	-	10	ns/V

## 10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
<b><math>T_{amb} = -40</math> °C to <math>+85</math> °C</b>						
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 1.65$ V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3$ V to 2.7 V	1.7	-	-	V
		$V_{CC} = 2.7$ V to 3.6 V	2.0	-	-	V
		$V_{CC} = 4.5$ V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
$V_{IL}$	LOW-level input voltage	$V_{CC} = 1.65$ V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3$ V to 2.7 V	-	-	0.7	V
		$V_{CC} = 2.7$ V to 3.6 V	-	-	0.8	V
		$V_{CC} = 4.5$ V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -100$ $\mu$ A; $V_{CC} = 1.65$ V to 5.5 V	$V_{CC} - 0.1$	-	-	V
		$I_O = -4$ mA; $V_{CC} = 1.65$ V	1.2	1.53	-	V
		$I_O = -8$ mA; $V_{CC} = 2.3$ V	1.9	2.13	-	V
		$I_O = -12$ mA; $V_{CC} = 2.7$ V	2.2	2.50	-	V
		$I_O = -24$ mA; $V_{CC} = 3.0$ V	2.3	2.60	-	V
		$I_O = -32$ mA; $V_{CC} = 4.5$ V	3.8	4.10	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 100$ $\mu$ A; $V_{CC} = 1.65$ V to 5.5 V	-	-	0.1	V
		$I_O = 4$ mA; $V_{CC} = 1.65$ V	-	0.08	0.45	V
		$I_O = 8$ mA; $V_{CC} = 2.3$ V	-	0.14	0.3	V
		$I_O = 12$ mA; $V_{CC} = 2.7$ V	-	0.19	0.4	V
		$I_O = 24$ mA; $V_{CC} = 3.0$ V	-	0.37	0.55	V
$I_O = 32$ mA; $V_{CC} = 4.5$ V	-	0.43	0.55	V		
$I_I$	input leakage current	$V_I = 5.5$ V or GND; $V_{CC} = 0$ V to 5.5 V	-	$\pm 0.1$	$\pm 1$	$\mu$ A
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 5.5$ V; $V_{CC} = 0$ V	-	$\pm 0.1$	$\pm 2$	$\mu$ A
$I_{CC}$	supply current	$V_I = 5.5$ V or GND; $V_{CC} = 1.65$ V to 5.5 V; $I_O = 0$ A	-	0.1	4	$\mu$ A

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$\Delta I_{CC}$	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V}$ ; $I_O = 0 \text{ A}$	-	5	500	$\mu\text{A}$
$C_i$	input capacitance		-	2.5	-	pF
<b><math>T_{\text{amb}} = -40 \text{ }^\circ\text{C to } +125 \text{ }^\circ\text{C}</math></b>						
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	$0.7 \times V_{CC}$	-	-	V
$V_{IL}$	LOW-level input voltage	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_O = -100 \mu\text{A}$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	$V_{CC} - 0.1$	-	-	V
		$I_O = -4 \text{ mA}$ ; $V_{CC} = 1.65 \text{ V}$	0.95	-	-	V
		$I_O = -8 \text{ mA}$ ; $V_{CC} = 2.3 \text{ V}$	1.7	-	-	V
		$I_O = -12 \text{ mA}$ ; $V_{CC} = 2.7 \text{ V}$	1.9	-	-	V
		$I_O = -24 \text{ mA}$ ; $V_{CC} = 3.0 \text{ V}$	2.0	-	-	V
		$I_O = -32 \text{ mA}$ ; $V_{CC} = 4.5 \text{ V}$	3.4	-	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_O = 100 \mu\text{A}$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	-	0.1	V
		$I_O = 4 \text{ mA}$ ; $V_{CC} = 1.65 \text{ V}$	-	-	0.70	V
		$I_O = 8 \text{ mA}$ ; $V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_O = 12 \text{ mA}$ ; $V_{CC} = 2.7 \text{ V}$	-	-	0.60	V
		$I_O = 24 \text{ mA}$ ; $V_{CC} = 3.0 \text{ V}$	-	-	0.80	V
		$I_O = 32 \text{ mA}$ ; $V_{CC} = 4.5 \text{ V}$	-	-	0.80	V
$I_I$	input leakage current	$V_I = 5.5 \text{ V or GND}$ ; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	-	$\pm 1$	$\mu\text{A}$
$I_{OFF}$	power-off leakage current	$V_I \text{ or } V_O = 5.5 \text{ V}$ ; $V_{CC} = 0 \text{ V}$	-	-	$\pm 2$	$\mu\text{A}$
$I_{CC}$	supply current	$V_I = 5.5 \text{ V or GND}$ ; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ ; $I_O = 0 \text{ A}$	-	-	4	$\mu\text{A}$
$\Delta I_{CC}$	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V}$ ; $I_O = 0 \text{ A}$	-	-	500	$\mu\text{A}$

[1] All typical values are measured at  $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ .

## 11. Dynamic characteristics

**Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground 0 V); for test circuit see Fig. 5.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation delay	nA, nB to nY; see Fig. 4 [2]						
		$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	1.3	3.9	8.8	1.3	11	ns
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	0.8	2.4	4.7	0.8	5.9	ns
		$V_{CC} = 2.7\text{ V}$	0.8	2.7	4.8	0.8	6.0	ns
		$V_{CC} = 3.0\text{ V to }3.6\text{ V}$	0.9	2.2	4.2	0.9	5.3	ns
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	0.7	1.7	3.2	0.7	4.0	ns
$C_{PD}$	power dissipation capacitance	per gate; $V_I = \text{GND to }V_{CC}$ [3]	-	14	-	-	-	pF

[1] Typical values are measured at nominal  $V_{CC}$  and at  $T_{amb} = 25\text{ °C}$ .

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

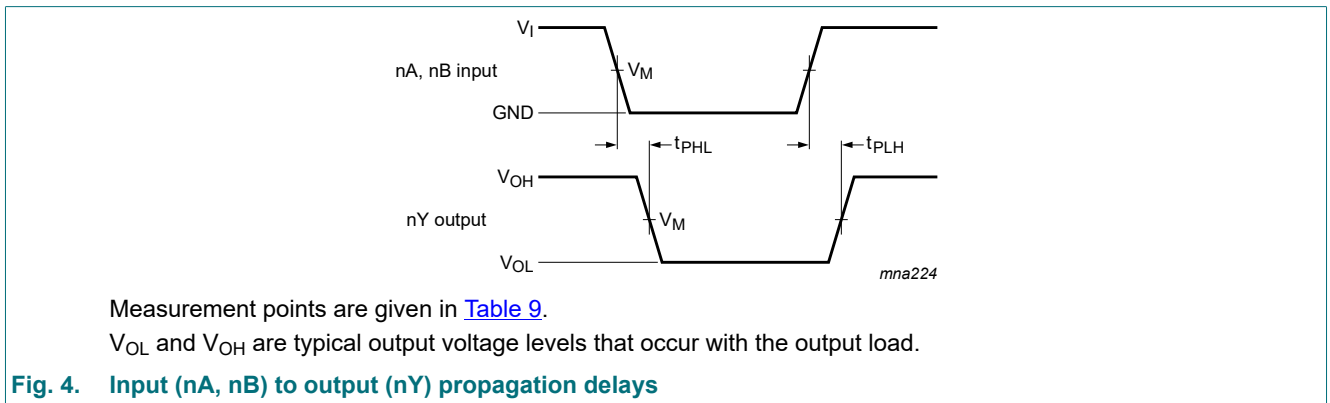
$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

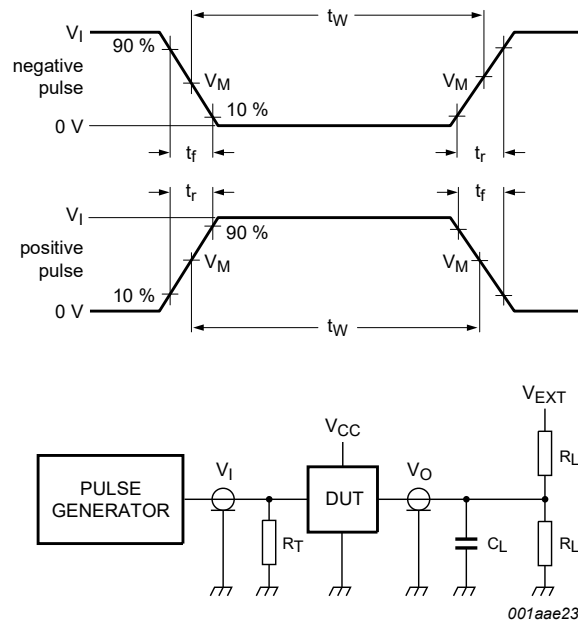
### 11.1. Waveform and test circuit



**Fig. 4. Input (nA, nB) to output (nY) propagation delays**

**Table 9. Measurement points**

Supply voltage	Input	Output
$V_{CC}$	$V_M$	$V_M$
1.65 V to 1.95 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$



Test data is given in [Table 10](#).

Definitions for test circuit:

$R_L$  = Load resistance;

$C_L$  = Load capacitance including jig and probe capacitance;

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator;

$V_{EXT}$  = Test voltage for switching times.

**Fig. 5. Test circuit for measuring switching times**

**Table 10. Test data**

Supply voltage	Input		Load		$V_{EXT}$
$V_{CC}$	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$
1.65 V to 1.95 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	1 k $\Omega$	open
2.3 V to 2.7 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	500 $\Omega$	open
2.7 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open
3.0 V to 3.6 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open
4.5 V to 5.5 V	$V_{CC}$	$\leq 2.5$ ns	50 pF	500 $\Omega$	open

## 12. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

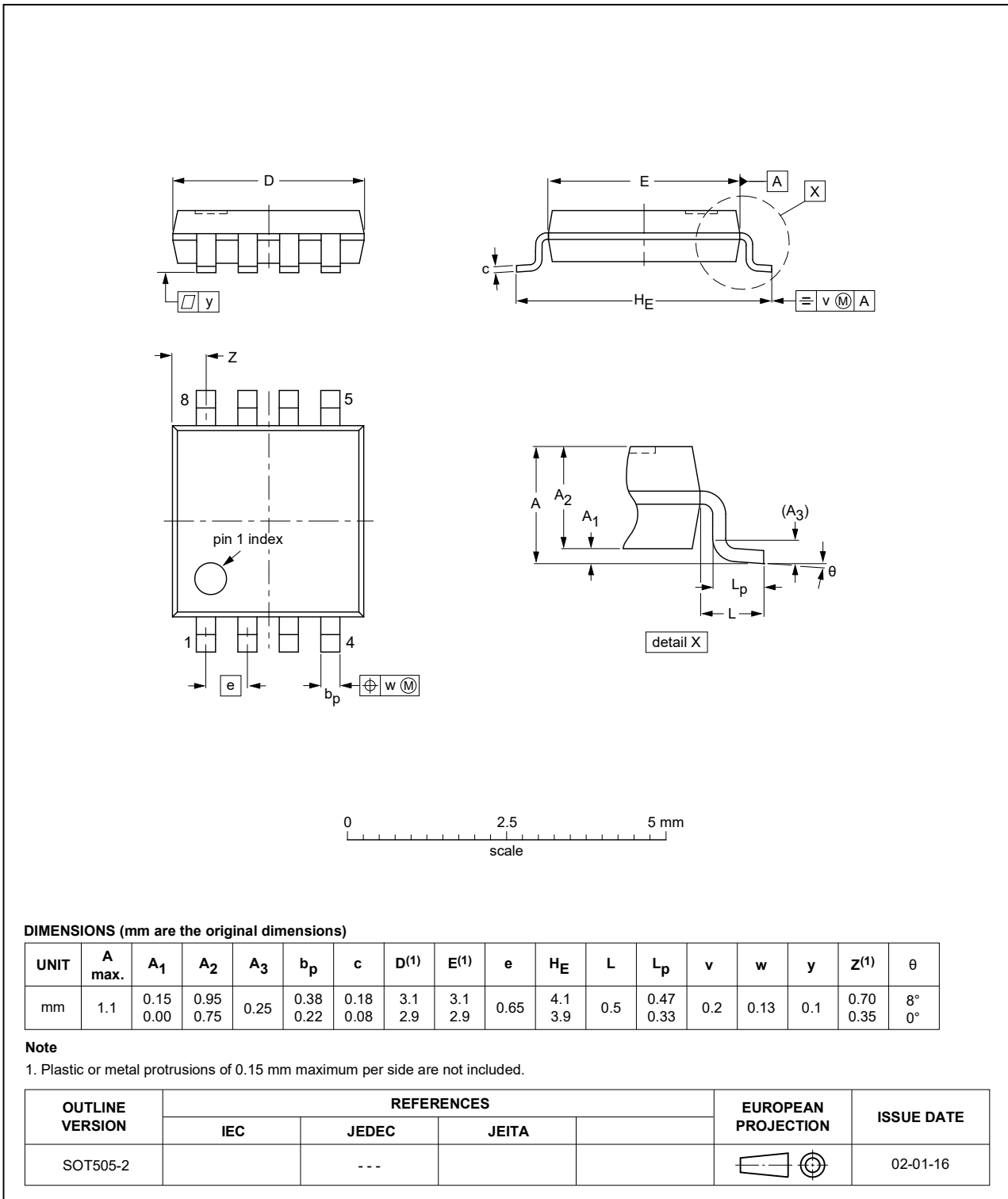


Fig. 6. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



Fig. 7. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm

SOT833-1



Fig. 8. Package outline SOT833-1 (XSON8)

XSON8: extremely thin small outline package; no leads;  
8 terminals; body 1.2 x 1.0 x 0.35 mm

SOT1116



Fig. 9. Package outline SOT1116 (XSON8)

XSON8: extremely thin small outline package; no leads;  
8 terminals; body 1.35 x 1.0 x 0.35 mm

SOT1203



Fig. 10. Package outline SOT1203 (XSON8)

X2SON8: plastic thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.35 x 0.8 x 0.32 mm

SOT1233-2

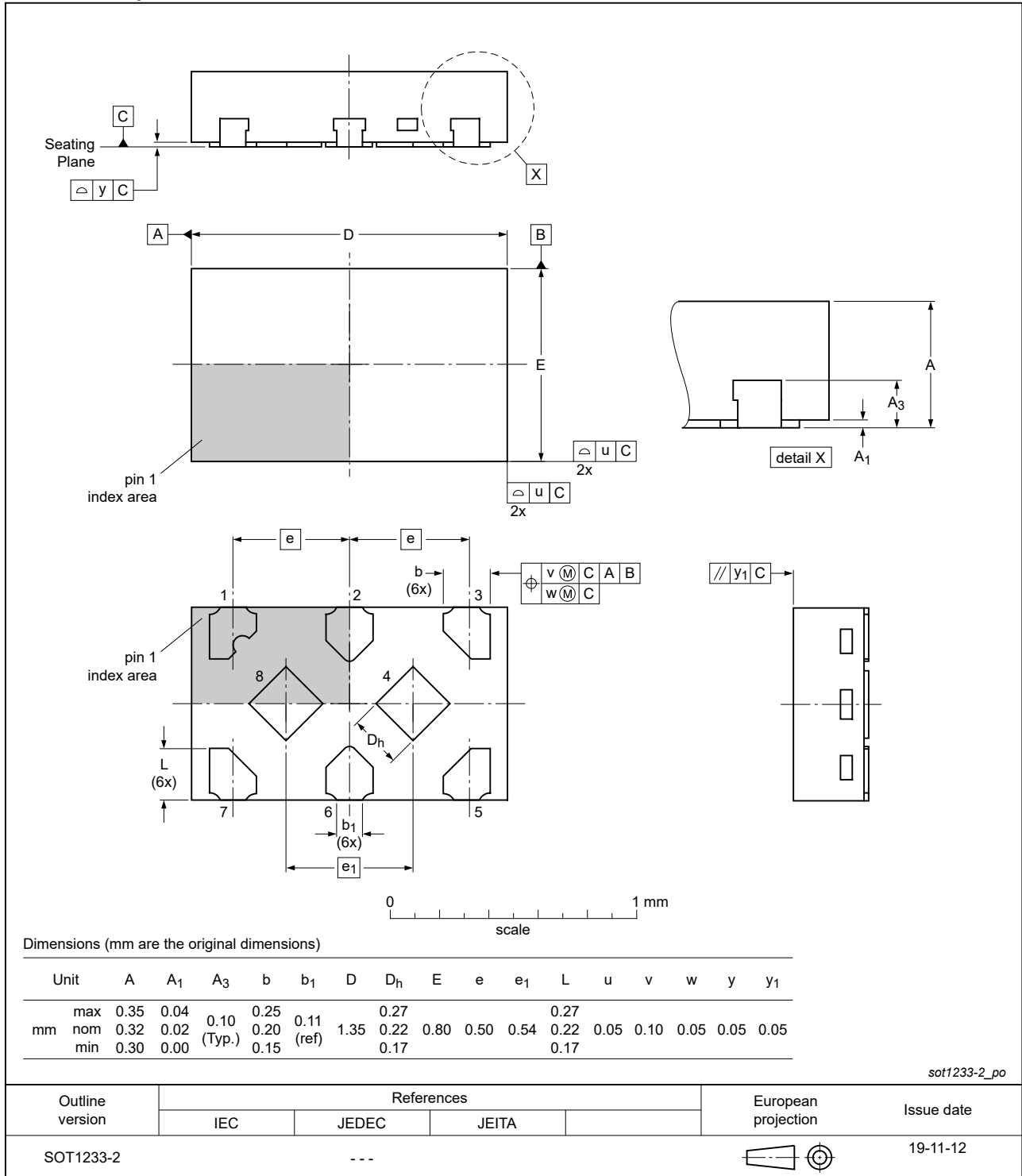


Fig. 11. Package outline SOT1233-2 (X2SON8)

## 13. Abbreviations

Table 11. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

## 14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2G32 v.17	20240812	Product data sheet	-	74LVC2G32 v.16
Modifications:	<ul style="list-style-type: none"> <li>Type number 74LVC2G32GF (SOT1089/XSON8) removed.</li> </ul>			
74LVC2G32 v.16	20230822	Product data sheet	-	74LVC2G32 v.15
Modifications:	<ul style="list-style-type: none"> <li><a href="#">Section 2</a>: ESD specification updated according to the latest JEDEC standard.</li> </ul>			
74LVC2G32 v.15	20220623	Product data sheet	-	74LVC2G32 v.14
Modifications:	<ul style="list-style-type: none"> <li>Package SOT1233 (X2SON8) changed to SOT1233-2 (X2SON8).</li> </ul>			
74LVC2G32 v.14	20220318	Product data sheet	-	74LVC2G32 v.13
Modifications:	<ul style="list-style-type: none"> <li>Type number 74LVC2G32GM (SOT902-2/XQFN8) removed.</li> <li><a href="#">Section 1</a> and <a href="#">Section 2</a> updated.</li> <li><a href="#">Table 5</a>: Derating values for <math>P_{tot}</math> total power dissipation have been updated.</li> </ul>			
74LVC2G32 v.13	20170703	Product data sheet	-	74LVC2G32 v.12
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74LVC2G32GX (SOT1233 / X2SON8) added.</li> <li>Type number 74LVC2G32GD removed.</li> </ul>			
74LVC2G32 v.12	20161215	Product data sheet	-	74LVC2G32 v.11
Modifications:	<ul style="list-style-type: none"> <li><a href="#">Table 7</a>: The maximum limits for leakage current and supply current have changed.</li> </ul>			
74LVC2G32 v.11	20130408	Product data sheet	-	74LVC2G32 v.10
Modifications:	<ul style="list-style-type: none"> <li>For type number 74LVC2G32GD XSON8U has changed to XSON8.</li> </ul>			
74LVC2G32 v.10	20120622	Product data sheet	-	74LVC2G32 v.9
Modifications:	<ul style="list-style-type: none"> <li>For type number 74LVC2G32GM the SOT code has changed to SOT902-2.</li> </ul>			
74LVC2G32 v.9	20111128	Product data sheet	-	74LVC2G32 v.8
Modifications:	<ul style="list-style-type: none"> <li>Legal pages updated.</li> </ul>			
74LVC2G32 v.8	20101110	Product data sheet	-	74LVC2G32 v.7
74LVC2G32 v.7	20080606	Product data sheet	-	74LVC2G32 v.6

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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